

1.0A Surface Mount General Purpose Rectifiers - 50V-1000V

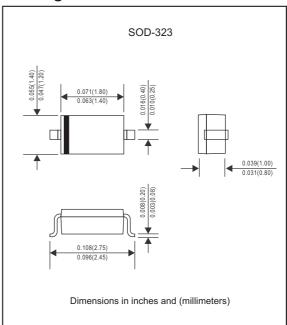
Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- → High temperature soldering guaranteed: 260°C/10 seconds at terminals
- ◆ Glass passivated chip junction

Mechanical data

- ◆ Case: JEDEC SOD-323 molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- ◆ Polarity: Color band denotes cathode end
- ◆ Mounting Position: Any

Package outline



Maximum ratings and Electrical Characteristics (AT T_A=25°C unless otherwise noted)

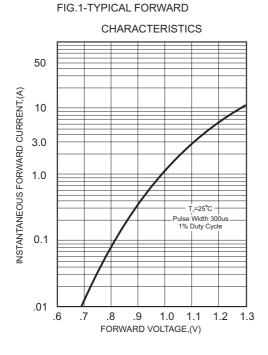
	SYMBOLS	S1AD3	S1BD3	S1DD3	S1GD3	S1JD3	S1KD3	S1MD3	UNITS
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at TL =110℃	l(AV)				1.0				Α
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	Ігѕм				15.0				А
Maximum instantaneous forward voltage at 1.0A	VF				1.1				V
Maximum DC reverse current Ta=25°C at rated DC blocking voltage Ta=100°C	IR				5.0 50.0				μΑ
Typical junction capacitance (NOTE 1)		5.0					pF		
Typical thermal resistance (NOTE 2)	RθJA				55.0				°C/W
Operating junction and storage temperature range		-55 to +150				°C			

Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C. 2.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas



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Rating and characteristic curves



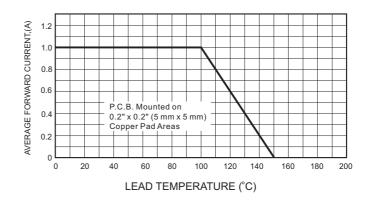


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

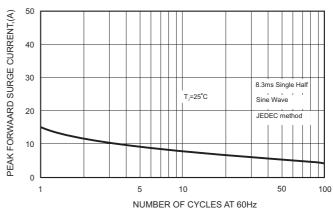


FIG.3 - TYPICAL REVERSE

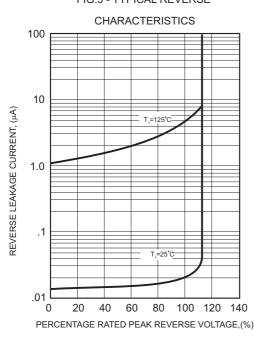
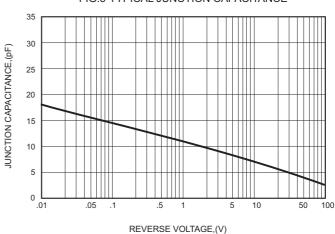


FIG.5-TYPICAL JUNCTION CAPACITANCE





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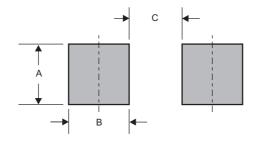
Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode	1 🗆 🕒 2	12

Marking

Type number	Marking code		
S1AD3	1A		
S1BD3	2A		
S1DD3	3A		
S1GD3	4A		
S1JD3	5A		
S1KD3	6A		
S1MD3	7A		

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	Α	В	С		
SOD-323	0.047 (1.20)	0.047 (1.20)	0.055 (1.40)		

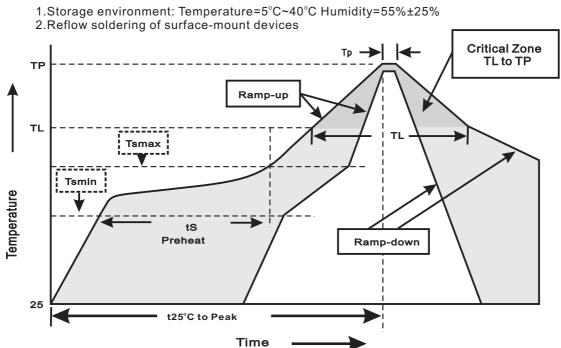
Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)
SOD-323	7"	3,000	4.0	30,000	183*183*123	178	382*262*387	240,000



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Suggested thermal profiles for soldering processes



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T∟ to T♭)	<3°C/sec
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(t _s)	150°C 200°C 60~120sec
Tsmax to T∟ -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(TL) -Time(tL)	217°C 60~260sec
Peak Temperature(T _P)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t _P)	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes

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